Hex Buffer with Enable

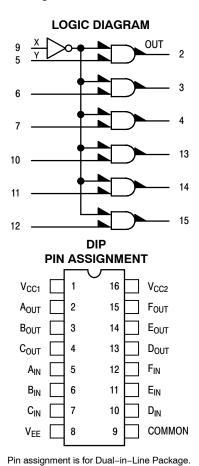
Description

The MC10H188 is a high-speed Hex Buffer with a common Enable input. When Enable is in the high-state, all outputs are in the low-state. When Enable is in the low-state, the outputs take the same state as the inputs.

This MECL 10H[™] part is a functional/pinout duplication of the standard MECL 10K[™] family part, with 100% improvement in propagation delay and no increase in power-supply current.

Features

- Propagation Delay, 1.3 ns Typical Data-to-Output
- Power Dissipation 180 mW Typ/Pkg (No Load)
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K Compatible
- Pb-Free Packages are Available*



TRUTH TABLE						
Inputs Output						
Х	Υ	OUT				
Γ	L	L				
Γ	Н	Н				
Η	L	L				
Н	Н	L				

V_{CC1} = Pin 1 $V_{CC2} = Pin 16$ $V_{EE} = Pin 8$



PLLC-20

= Assembly Location А WL, L = Wafer Lot YY, Y = Year WW. W = Work Week G = Pb-Free Package

*For additional marking information, refer to Application Note AND8002/D.

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

For PLCC pin assignment, see the Pin Conversion Tables on page 18

of the ON Semiconductor MECL Data Book (DL122/D).

CDIP-16 L SUFFIX CASE 620A	MC10H188L AWLYYWW UUUUUUUU 1
16 PDIP-16	16 <u> </u>
P SUFFIX CASE 648	





ON Semiconductor®

http://onsemi.com

16

MARKING DIAGRAMS*

MC10H188L

ALYWG

1 20

10H188G

AWLYYWW

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FN SUFFIX CASE 775

ORDERING INFORMATION See detailed ordering and shipping information in the package dimensions section on page 3 of this data sheet.

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Table 1. MAXIMUM RATINGS

Symbol	Characteristic	Rating	Unit
V_{EE}	Power Supply (V _{CC} = 0)	-8.0 to 0	Vdc
VI	Input Voltage (V _{CC} = 0)	0 to V _{EE}	Vdc
l _{out}	Output Current – Continuous – Surge	50 100	mA
T _A	Operating Temperature Range	0 to +75	°C
T _{stg}	Storage Temperature Range – Plastic – Ceramic	-55 to +150 -55 to +165	°C ℃

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

Table 2. ELECTRICAL CHARACTERISTICS (V_{EE} = -5.2 V $\pm 5\%$) (Note)

		0 °		25 °		75 °		
Symbol	Characteristic	Min	Max	Min	Max	Min	Max	Unit
١ _E	Power Supply Current	-	46	-	42	-	46	mA
I _{inH}	Input Current High	-	495	-	310	-	310	μΑ
I _{inL}	Input Current Low	0.5	-	0.5	-	0.3	-	μΑ
V _{OH}	High Output Voltage	-1.02	-0.84	-0.98	-0.81	-0.92	-0.735	Vdc
V _{OL}	Low Output Voltage	-1.95	-1.63	-1.95	-1.63	-1.95	-1.60	Vdc
VIH	High Input Voltage	-1.17	-0.84	-1.13	-0.81	-1.07	-0.735	Vdc
V _{IL}	Low Input Voltage	-1.95	-1.48	-1.95	-1.48	-1.95	-1.45	Vdc

1. Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 lfpm is maintained. Outputs are terminated through a 50 Ω resistor to -2.0 V.

Table 3. AC PARAMETERS

		0 °		25 °		75 °		
Symbol	Characteristic	Min	Max	Min	Max	Min	Max	Unit
t _{pd}	Propagation Delay Enable Data	0.7 0.7	2.2 1.9	0.7 0.7	2.2 1.9	0.7 0.7	2.2 1.9	ns
t _r	Rise Time	0.7	2.4	0.7	2.4	0.7	2.4	ns
t _f	Fall Time	0.7	2.4	0.7	2.4	0.7	2.4	ns

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

ORDERING INFORMATION

Device	Package	Shipping [†]
MC10H188FN	PLLC-20	46 Units / Rail
MC10H188FNG	PLLC-20 (Pb-Free)	46 Units / Rail
MC10H188FNR2	PLLC-20	500 / Tape & Reel
MC10H188FNR2G	PLLC-20 (Pb-Free)	500 / Tape & Reel
MC10H188L	CDIP-16	25 Unit / Rail
MC10H188M	SOEIAJ-16	50 Unit / Rail
MC10H188MG	SOEIAJ-16 (Pb-Free)	50 Unit / Rail
MC10H188MEL	SOEIAJ-16	2000 / Tape & Reel
MC10H188MELG	SOEIAJ-16 (Pb-Free)	2000 / Tape & Reel
MC10H188P	PDIP-16	25 Unit / Rail
MC10H188PG	PDIP-16 (Pb-Free)	25 Unit / Rail

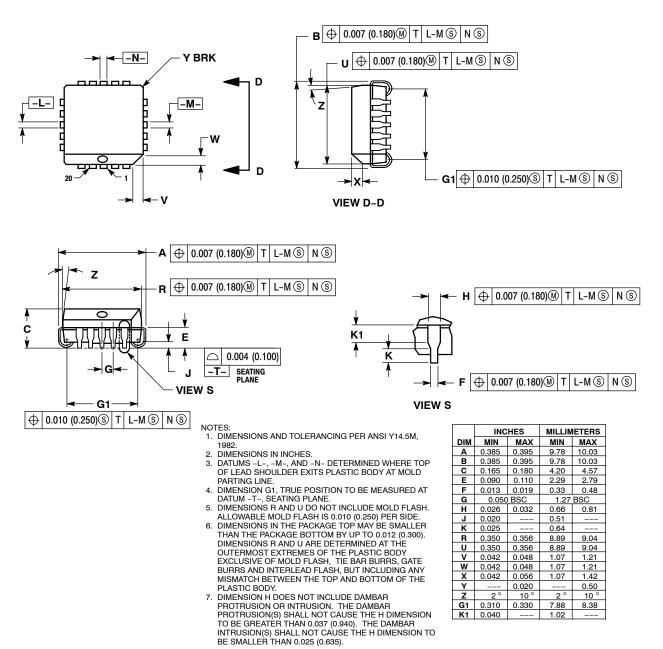
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

MC10H188

PACKAGE DIMENSIONS



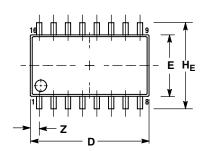
CASE 775-02 ISSUE E

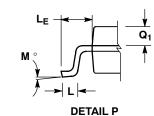


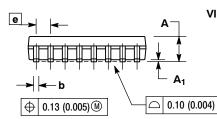
MC10H188

PACKAGE DIMENSIONS

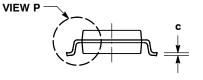
SOEIAJ-16 CASE 966-01 **ISSUE A**







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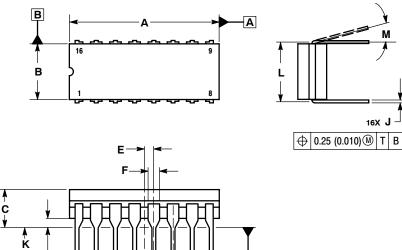


- NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI

- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.
 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
 4. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
 5. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018). TO BE 0.46 (0.018).

	MILLIN	IETERS	INCHES			
DIM	MIN	MAX	MIN	MAX		
Α		2.05		0.081		
A ₁	0.05	0.20	0.002	0.008		
p	0.35	0.50	0.014	0.020		
C	0.10	0.20	0.007	0.011		
D	9.90	10.50	0.390	0.413		
Е	5.10	5.45	0.201	0.215		
e	1.27	BSC	0.050	BSC		
HE	7.40	8.20	0.291	0.323		
L	0.50	0.85	0.020	0.033		
LΕ	1.10	1.50	0.043	0.059		
М	0 °	10 °	0 °	10 °		
Q1	0.70	0.90	0.028	0.035		
Ζ		0.78		0.031		

CDIP-16 L SUFFIX CERAMIC DIP PACKAGE CASE 620A-01 **ISSUE O**



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NOTES:

- NOTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. 2. CONTROLLING DIMENSION: INCH. 3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL. 4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC PODY
- BODY. THIS DRAWING REPLACES OBSOLETE CASE OUTLINE 620-10. 5

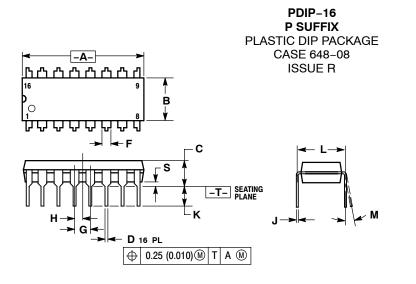
	INC	HES	MILLIMETERS				
DIM	MIN	MAX	MIN	MAX			
Α	0.750	0.785	19.05	19.93			
В	0.240	0.295	6.10	7.49			
С		0.200		5.08			
D	0.015	0.020	0.39	0.50			
Е	0.050	BSC	1.27 BSC				
F	0.055	0.065	1.40	1.65			
G	0.100	BSC	2.54 BSC				
Н	0.008	0.015	0.21	0.38			
K	0.125	0.170	3.18	4.31			
L	0.300 BSC		7.62 BSC				
М	0 °	15 °	0 °	15 °			
Ν	0.020	0.040	0.51	1.01			

– 16X D

⊕ 0.25 (0.010) M T A

MC10H188

PACKAGE DIMENSIONS



NOTES:

DIMENSIONING AND TOLERANCING PER ANSI Y14.5M. 1982.

CONTROLLING DIMENSION: INCH.

DIMENSION L TO CENTER OF LEADS WHEN 3

FORMED PARALLEL DIMENSION B DOES NOT INCLUDE MOLD FLASH. ROUNDED CORNERS OPTIONAL. 5.

	INC	HES	MILLIM	ETERS	
DIM	MIN MAX		MIN	MAX	
Α	0.740	0.770	18.80	19.55	
В	0.250	0.270	6.35	6.85	
С	0.145	0.175	3.69	4.44	
D	0.015	0.021	0.39	0.53	
F	0.040	0.70	1.02	1.77	
G	0.100	BSC	2.54 BSC		
Н	0.050	0.050 BSC		BSC	
J	0.008	0.015	0.21	0.38	
K	0.110	0.130	2.80	3.30	
L	0.295	0.305	7.50	7.74	
Μ	0 °	10 °	0 °	10 °	
S	0.020	0.040	0.51	1.01	

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